

# LH5P8129

CMOS 1M (128K × 8)  
CS-Control Pseudo-Static RAM

## FEATURES

- 131,072 × 8 bit organization
- Access times (MAX.): 60/80/100 ns
- Cycle times (MIN.): 100/130/160 ns
- Single +5 V power supply
- Pin compatible with 1M standard SRAM
- Power consumption:
  - Operating: 572/385/275 mW (MAX.)
  - Standby (TTL level): 5.5 mW (MAX.)
  - Standby (CMOS level): 1.1 mW (MAX.)
- TTL compatible I/O
- Available for auto-refresh and self-refresh modes
- 512 refresh cycles/8 ms
- Packages:
  - 32-pin, 600-mil DIP
  - 32-pin, 525-mil SOP
  - 32-pin, 8 × 20 mm<sup>2</sup> TSOP (Type I)

## DESCRIPTION

The LH5P8129 is a 1M bit Pseudo-Static RAM organized as 131,072 × 8 bits. It is fabricated using silicon-gate CMOS process technology.

A PSRAM uses on-chip refresh circuitry with a DRAM memory cell for pseudo static operation which eliminates external clock inputs, while considering the pinout compatibility with industry standard SRAMs. The advantage is the cost savings realized with the lower cost PSRAM.

The LH5P8129 PSRAM has a built-in oscillator, which makes it easy to refresh memories without external clocks.

## PIN CONNECTIONS

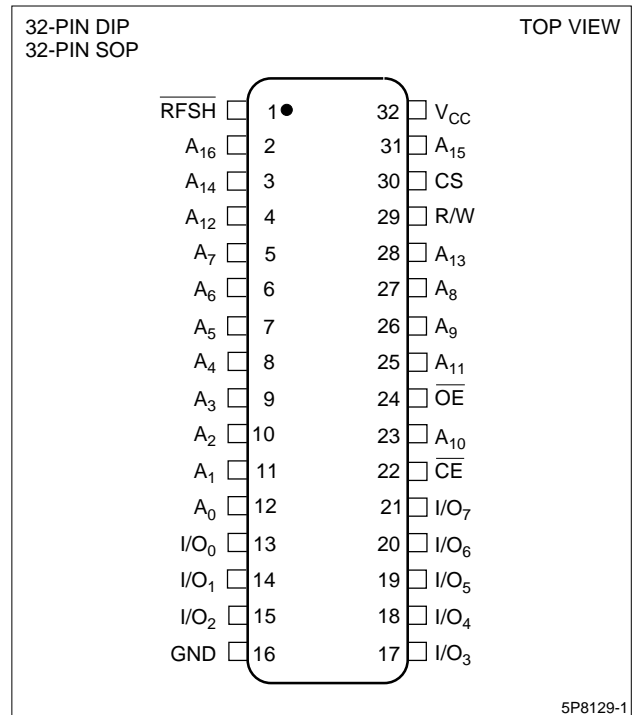
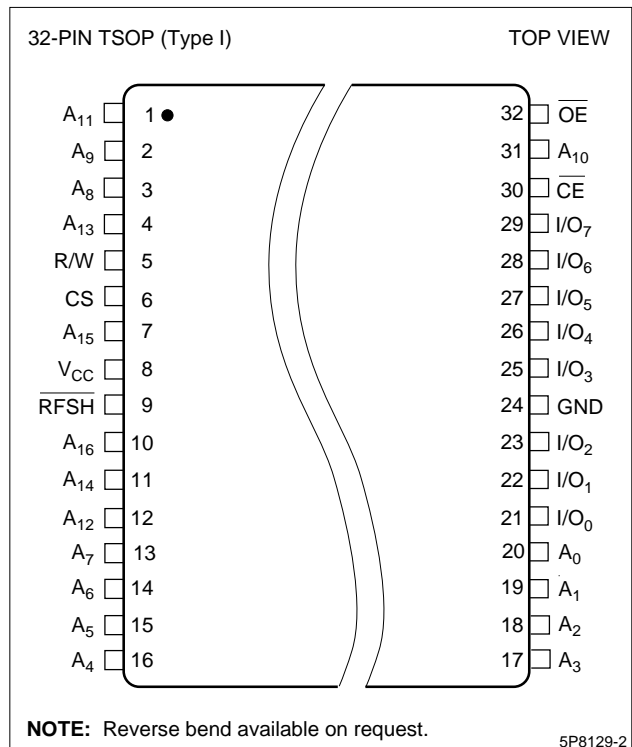


Figure 1. Pin Connections for DIP and SOP Packages



NOTE: Reverse bend available on request.

Figure 2. Pin Connections for TSOP Package

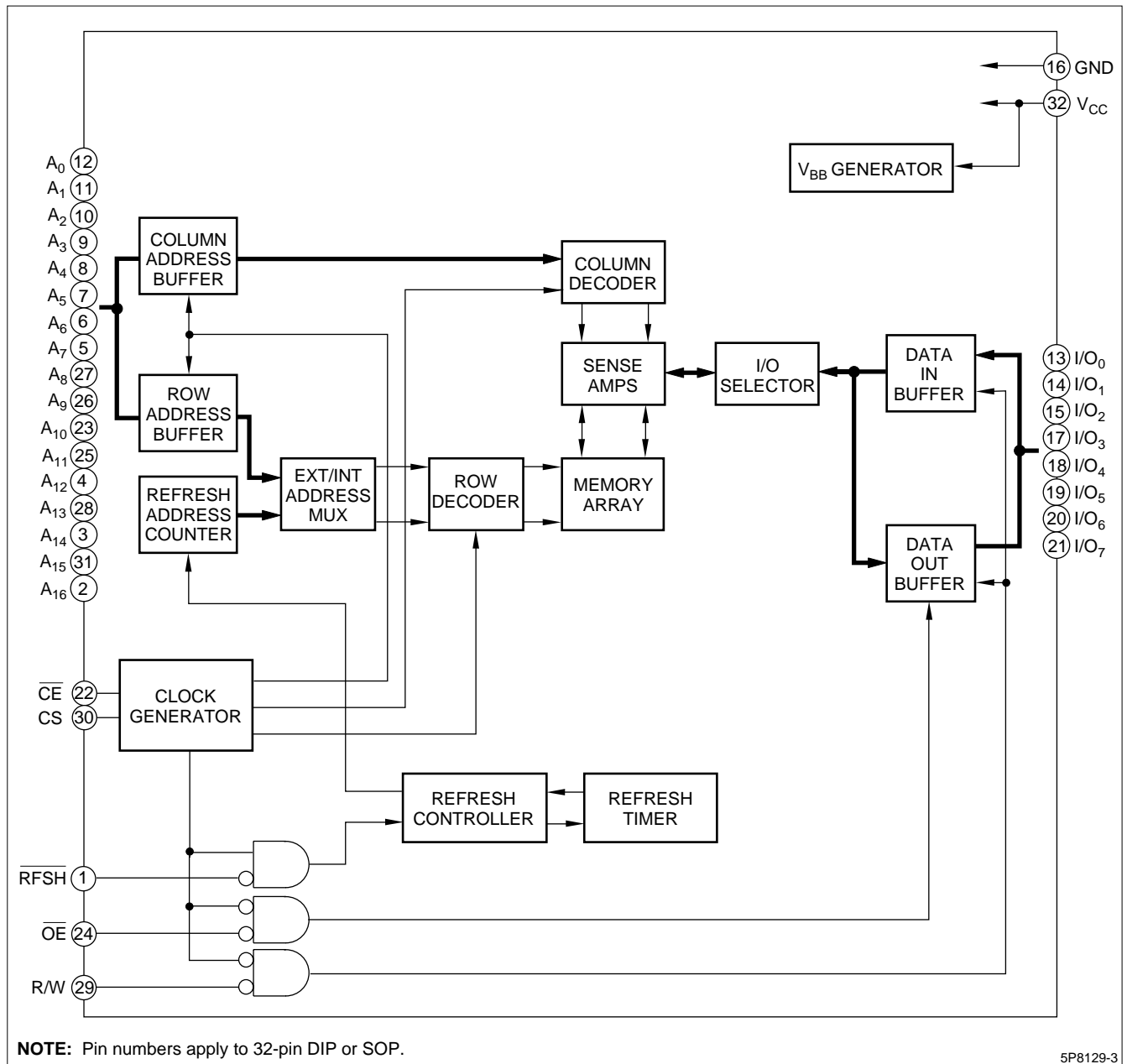


Figure 3. LH5P8129 Block Diagram

**PIN DESCRIPTION**

SIGNAL	PIN NAME
A <sub>0</sub> - A <sub>16</sub>	Address input
R/W	Read/Write input
OE	Output Enable input
CE	Chip Enable input

SIGNAL	PIN NAME
CS	Chip Select input
RFSH	Refresh input
I/O <sub>0</sub> - I/O <sub>7</sub>	Data input/output

## TRUTH TABLE

$\overline{CE}$	CS	$\overline{OE}$	R/W	$\overline{RFSH}$	A <sub>0</sub> - A <sub>16</sub>	I/O <sub>1</sub> - I/O <sub>8</sub>	MODE
L	H	L	H	X	VX	D <sub>OUT</sub>	Read
L	H	X	L	X	VX	D <sub>IN</sub>	Write
L	H	H	H	X	VY	High-Z	CE only refresh
L	L	X	X	X	X	High-Z	CS standby
H	X	X	X	L	X	High-Z	Auto/Self refresh
H	X	X	X	H	X	High-Z	Standby

## NOTES:

H = High at  $V_{IN} = V_{CC} + 0.3$  V to  $V_{IH}$  (MIN.)

L = Low at  $V_{IN} = V_{IL}$  (MAX.) to -1.0 V

X = Don't care at  $V_{CC} + 0.3$  V to -1.0 V

VX = A<sub>0</sub>-A<sub>16</sub> address input when  $\overline{CE} = L$ , then Don't Care

VY = A<sub>0</sub>-A<sub>8</sub> address input when  $\overline{CE} = L$ , then Don't Care,  
and A<sub>9</sub>-A<sub>16</sub> address = Don't Care at  $V_{CC} + 0.3$  V to -1.0 V

## ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	RATING	UNIT	NOTE
Applied voltage on any pins	$V_T$	-1.0 to +7.0	V	1
Output short circuit current	$I_O$	50	mA	
Power dissipation	$P_D$	600	mW	
Operating temperature	$T_{opr}$	0 to +70	°C	
Storage temperature	$T_{stg}$	-65 to +150	°C	

## NOTE:

- The maximum applicable voltage on any pin with respect to GND.

RECOMMENDED OPERATING CONDITIONS (T<sub>A</sub> = 0 to +70°C)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage	V <sub>CC</sub>	4.5	5.0	5.5	V
	GND	0	0	0	V
Input voltage	V <sub>IH</sub>	2.4		V <sub>CC</sub> + 0.3	V
	V <sub>IL</sub>	-1.0		0.8	V

CAPACITANCE (T<sub>A</sub> = 0 to +70°C, f = 1 MHz, V<sub>CC</sub> = 5.0 V ±10%)

PARAMETER	CONDITIONS	SYMBOL	MIN.	MAX.	UNIT
Input capacitance	A <sub>0</sub> - A <sub>16</sub>	C <sub>IN1</sub>		8	pF
	R/W, OE	C <sub>IN2</sub>		5	pF
	CE, CS	C <sub>IN3</sub>		5	pF
	RFSH	C <sub>IN4</sub>		5	pF
Input/output capacitance	I/O <sub>1</sub> - I/O <sub>7</sub>	C <sub>OUT1</sub>		10	pF

**DC CHARACTERISTICS** ( $T_A = 0$  to  $+70^\circ\text{C}$ ,  $V_{CC} = 5.0\text{ V} \pm 10\%$ )

PARAMETER		SYMBOL	CONDITIONS	MIN.	MAX.	UNIT	NOTE
Operating current	LH5P8129-60	$I_{CC1}$	$t_{RC} = t_{RC} (\text{MIN.})$		104	mA	1, 2
	LH5P8129-80				70		
	LH5P8129-10				50		
Standby current	TTL Input	$I_{CC2}$			1	mA	1, 3
	CMOS Input				0.2		1, 4
Self-refresh average current	TTL Input	$I_{CC3}$			1	mA	1, 5
	CMOS Input				0.2		1, 6
Input leakage current		$I_{LI}$	$0\text{ V} \leq V_{IN} \leq 6.5\text{ V}$ $0\text{ V}$ except on test pins	-10	10	$\mu\text{A}$	
I/O leakage current		$I_{LO}$	$0\text{ V} \leq V_{OUT} \leq V_{CC} + 0.3\text{ V}$ Output in high-impedance state	-10	10	$\mu\text{A}$	
Output HIGH voltage		$V_{OH}$	$I_{OUT} = -1\text{ mA}$	2.4		V	
Output LOW voltage		$V_{OL}$	$I_{OUT} = 4\text{ mA}$		0.4	V	

**NOTES:**

1. Specified values are with outputs open.
2.  $I_{CC1}$  depends on the cycle time
3.  $CE = V_{IH}$ ,  $RFSH = V_{IH}$
4.  $CE = V_{CC} - 0.2\text{ V}$ ,  $RFSH = V_{CC} - 0.2\text{ V}$
5.  $CE = V_{IH}$ ,  $RFSH = V_{IL}$
6.  $CE = V_{CC} - 0.2\text{ V}$ ,  $RFSH = 0.2\text{ V}$

AC ELECTRICAL CHARACTERISTICS <sup>1,2,3</sup> ( $T_A = 0$  to  $+70^\circ\text{C}$ ,  $V_{CC} = 5.0\text{ V} \pm 10\%$ )

PARAMETER	SYMBOL	LH5P8129-60		LH5P8129-80		LH5P8129-10		UNIT	NOTE
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.		
Random read, write cycle time	$t_{RC}$	100		130		160		ns	
Read modify write cycle time	$t_{RMW}$	165		195		235		ns	
CE pulse width	$t_{CE}$	60	10,000	80	10,000	100	10,000	ns	
CE precharge time	$t_p$	40		40		50		ns	
CS setup time	$t_{CSS}$	0		0		0		ns	
CS hold time	$t_{CSH}$	15		20		25		ns	
Address setup time	$t_{AS}$	0		0		0		ns	4
Address hold time	$t_{AH}$	15		20		25		ns	4
Read command setup time	$t_{RCS}$	0		0		0		ns	
Read command hold time	$t_{RCH}$	0		0		0		ns	
CE access time	$t_{CEA}$		60		80		100	ns	5
OE access time	$t_{OEA}$		25		30		35	ns	5
CE to output in Low-Z	$t_{CLZ}$	20		20		20		ns	
OE to output in Low-Z	$t_{OLZ}$	0		0		0		ns	
Output enable from end of write	$t_{WLZ}$	0		0		0		ns	
Chip disable to output in High-Z	$t_{CHZ}$		20		25		30	ns	
Output disable to output in High-Z	$t_{OHZ}$		20		25		30	ns	
Write enable to output in High-Z	$t_{WHZ}$		20		25		30	ns	
OE setup time	$t_{OES}$	0		0		0		ns	
OE hold time	$t_{OEH}$	10		10		10		ns	
Write command pulse width	$t_{WP}$	30		30		30		ns	
Write command setup time	$t_{WCS}$	30		30		30		ns	
Write command hold time	$t_{WCH}$	40		50		60		ns	
Data setup time from write	$t_{DSW}$	25		30		35		ns	6
Data setup time from CE	$t_{DSC}$	25		30		35		ns	6
Data hold time from write	$t_{DHW}$	0		0		0		ns	6
Data hold time from CE	$t_{DHC}$	0		0		0		ns	6
Transition time (rise and fall)	$t_T$	3	35	3	35	3	35	ns	
Refresh time interval	$t_{REF}$		8		8		8	ms	
Refresh command hold time	$t_{RHC}$	15		15		15		ns	
Auto refresh cycle time	$t_{FC}$	100		130		160		ns	
Refresh delay time from CE	$t_{RFD}$	30		40		50		ns	
Refresh pulse width (Auto refresh)	$t_{FAP}$	30	8,000	30	8,000	30	8,000	ns	
Refresh precharge time (Auto refresh)	$t_{FP}$	30		30		30		ns	
Refresh pulse width (Self refresh)	$t_{FAS}$	8,000		8,000		8,000		ns	
CE delay time from refresh precharge (Self refresh)	$t_{FRS}$	140		160		190		ns	

## NOTES:

- In order to initialize the circuit, an initial pause of 100  $\mu\text{s}$  with  $\overline{\text{CE}} = V_{IH}$ ,  $\overline{\text{RFSH}} = V_{IH}$  after power-up, followed by at least 8 dummy cycles.
- AC characteristics are measured at  $t_T = 5\text{ ns}$ .
- AC characteristics are measured at the following condition (see figure at right).
- Measured with a load equivalent to 2TTL + 100 pF.
- Address is latched at the negative edge of  $\overline{\text{CE}}$ .
- Data is latched at the positive edge of R/W or at the positive edge of  $\overline{\text{CE}}$ .

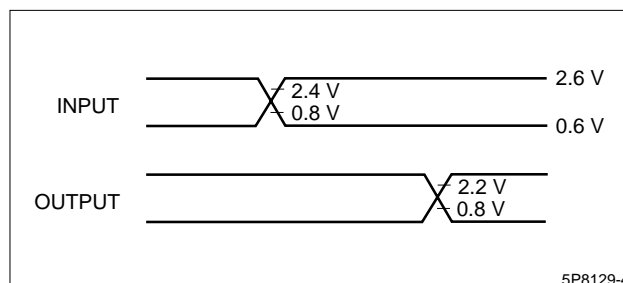
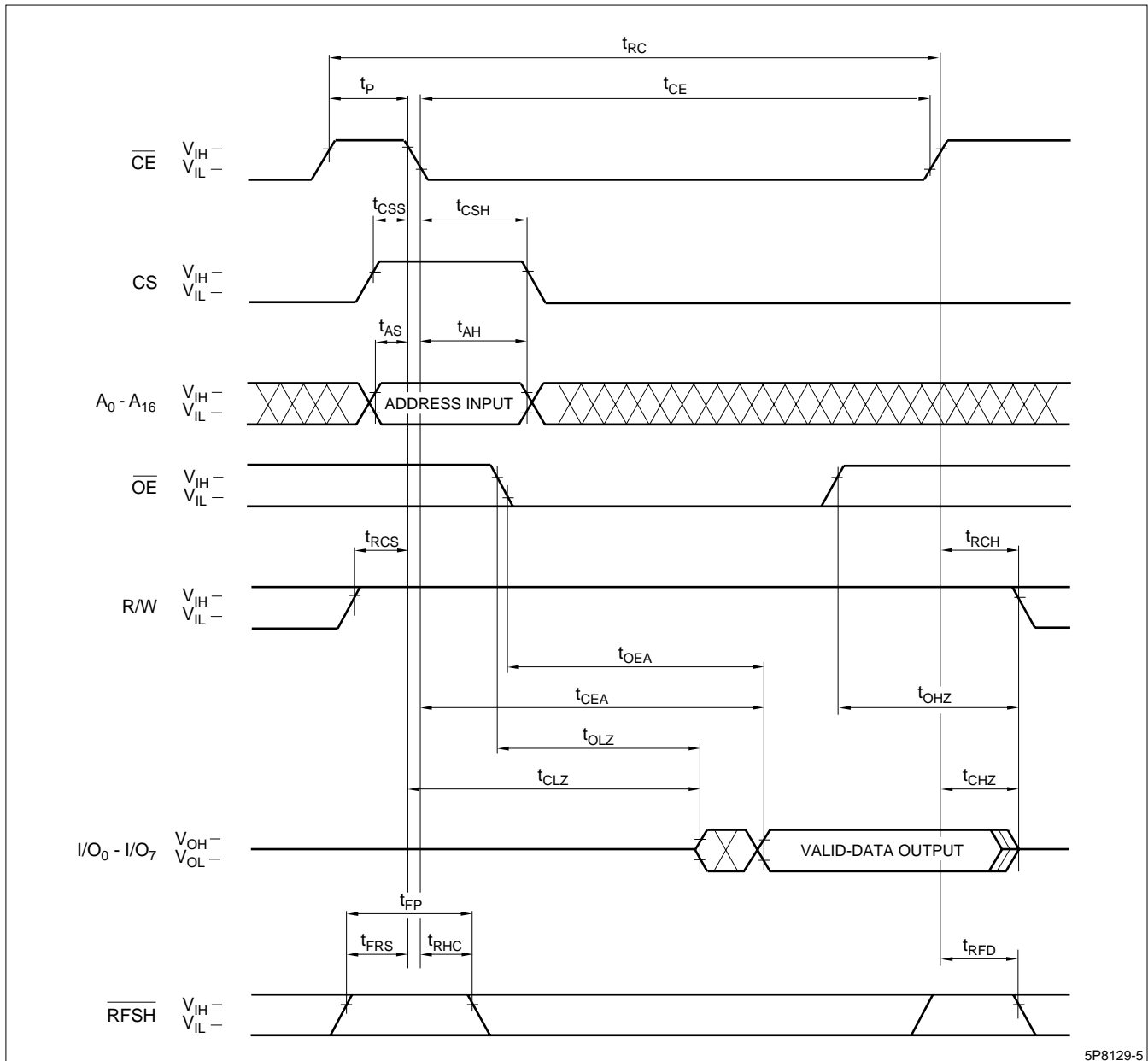
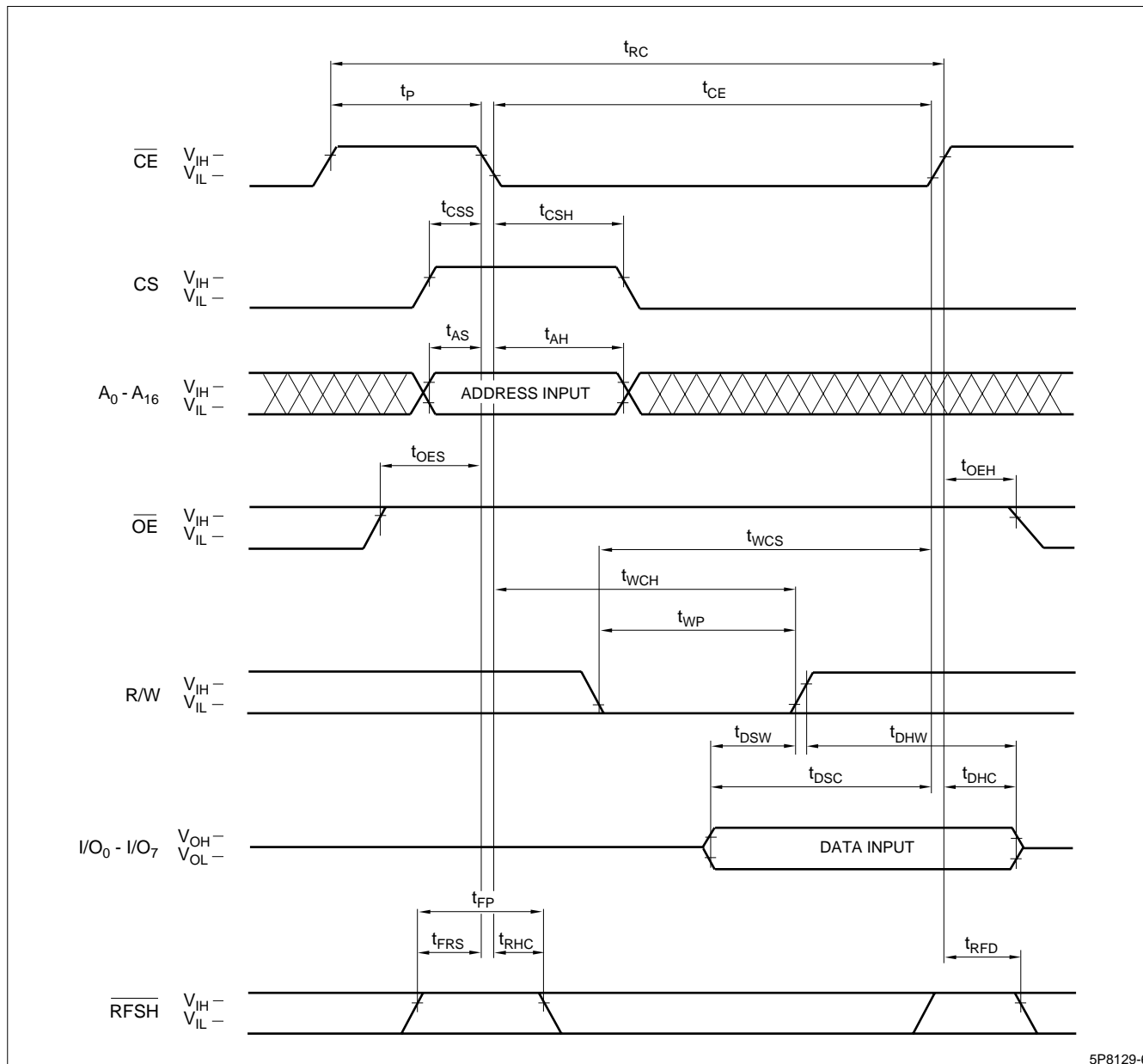


Figure 4. AC Characteristics



5P8129-5

Figure 5. Read Cycle



5P8129-6

Figure 6. Write Cycle 1 ( $\overline{OE}$  = HIGH)

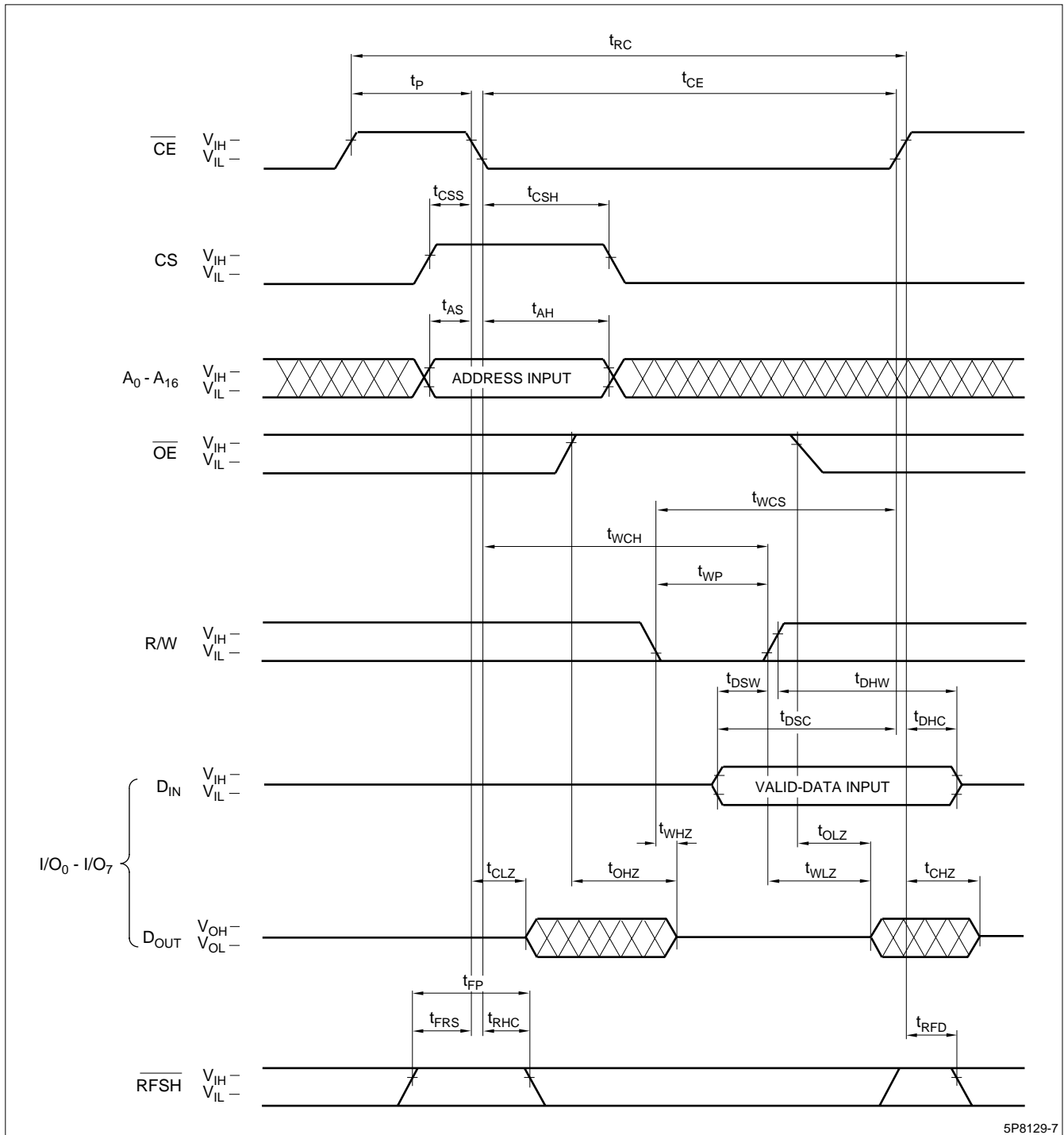
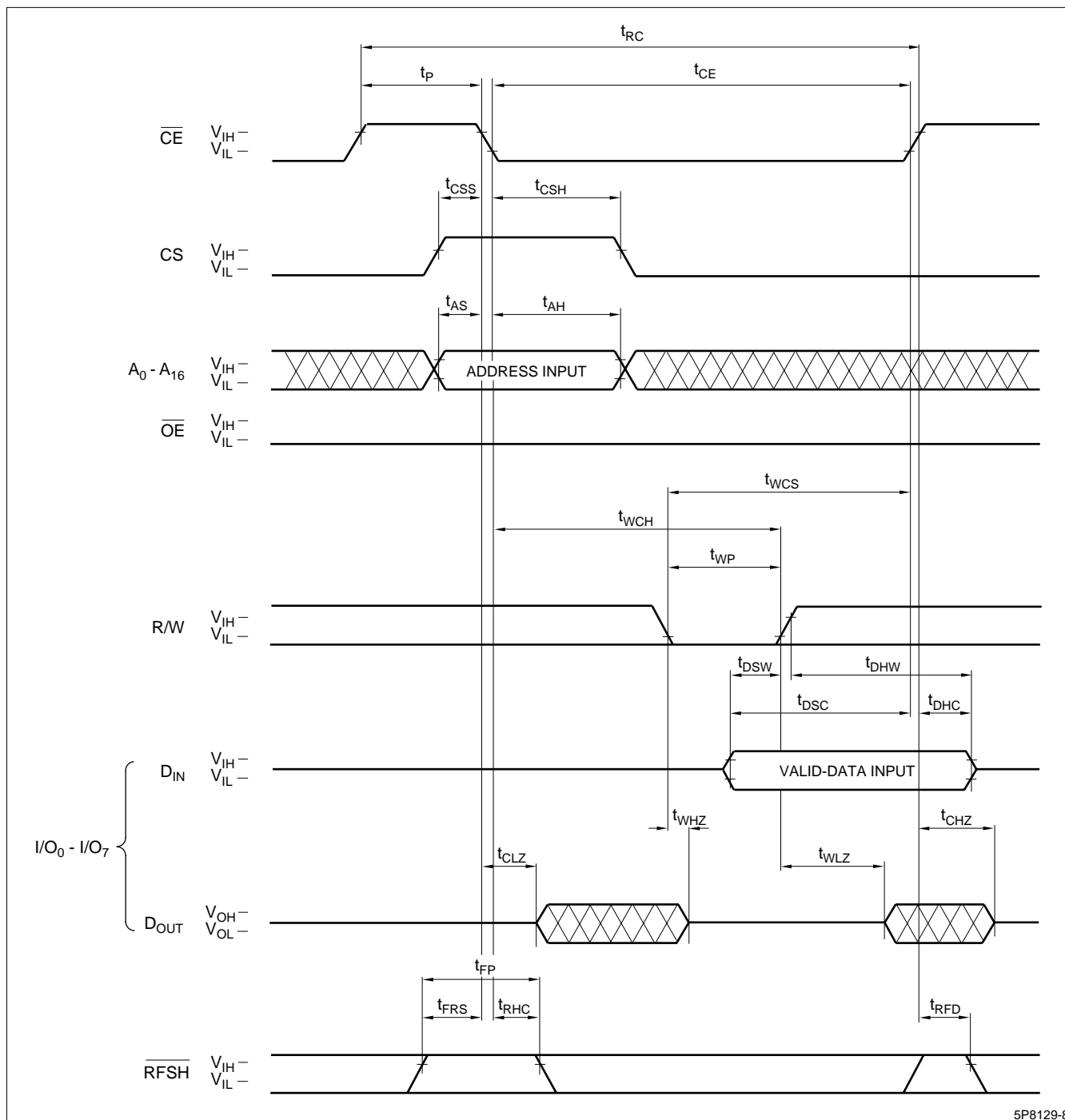


Figure 7. Write Cycle 2 (OE Clock)

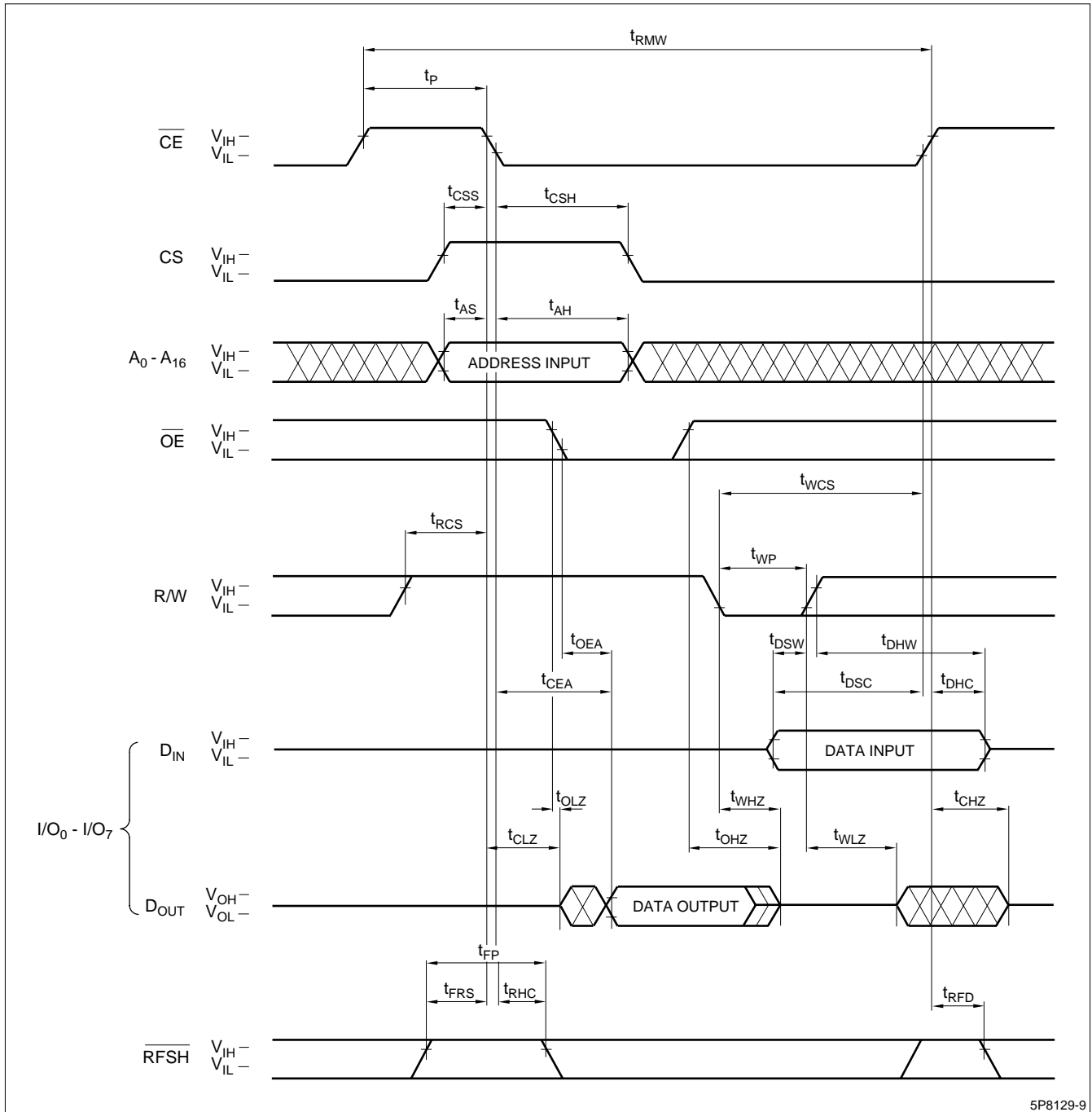
5P8129-7





5P8129-8

Figure 8. Write Cycle 3 (OE = LOW)



5P8129-9

Figure 9. Read-Modify-Write Cycle

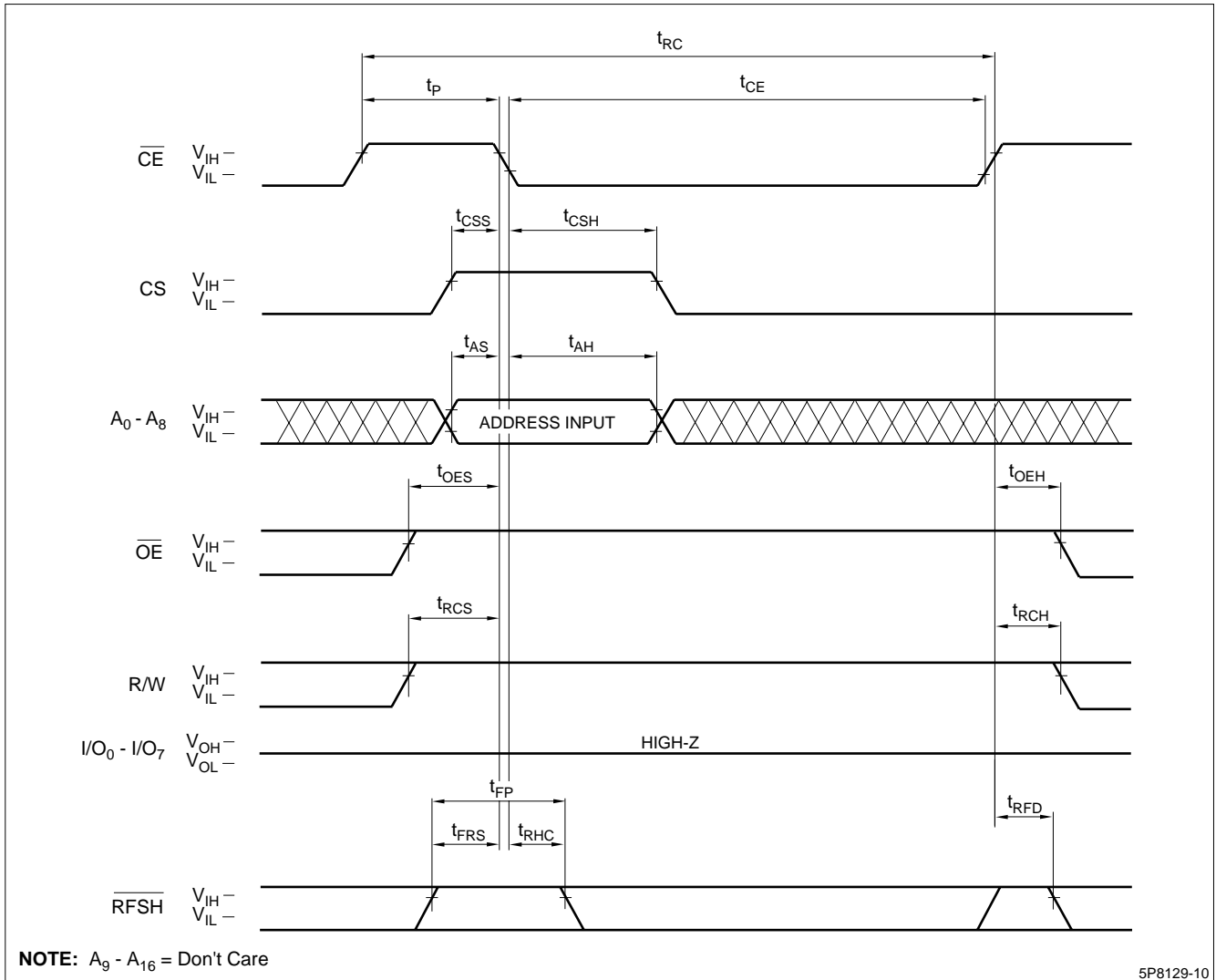


Figure 10. CE Only Refresh

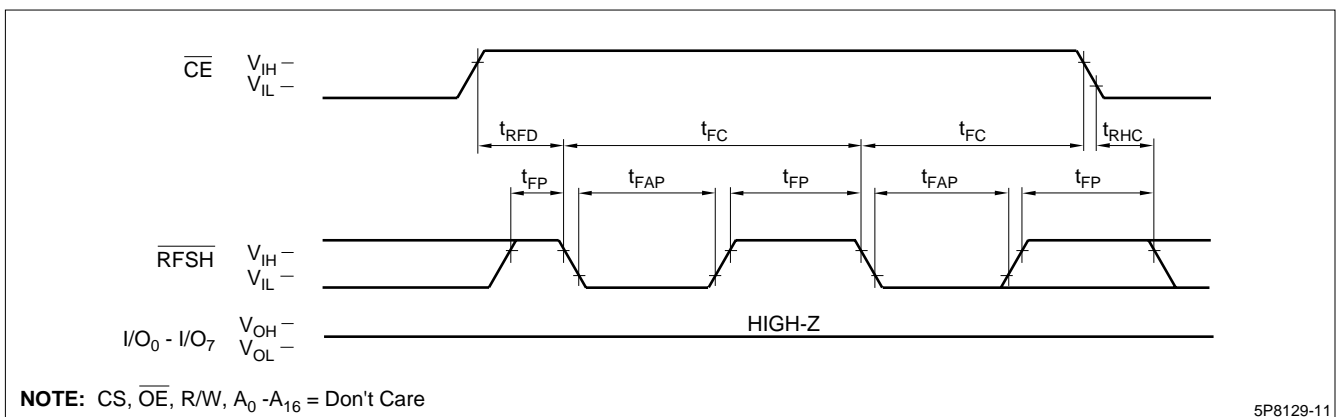


Figure 11. Auto Refresh Cycle

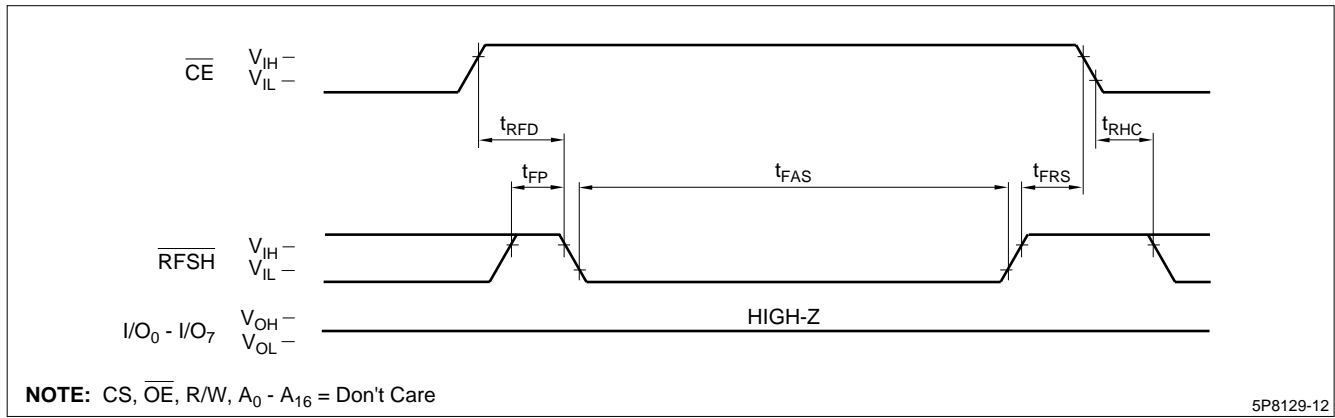


Figure 12. Self Refresh Cycle

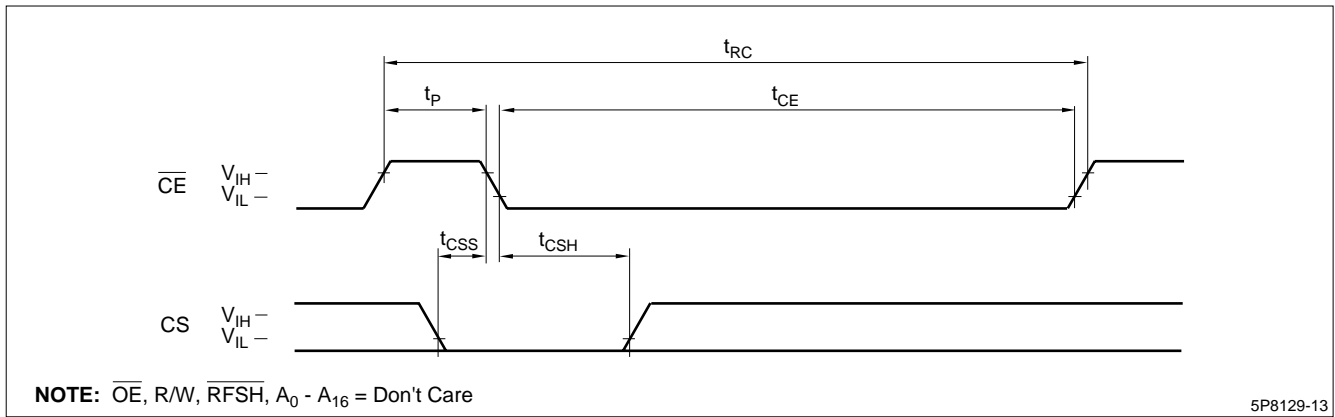
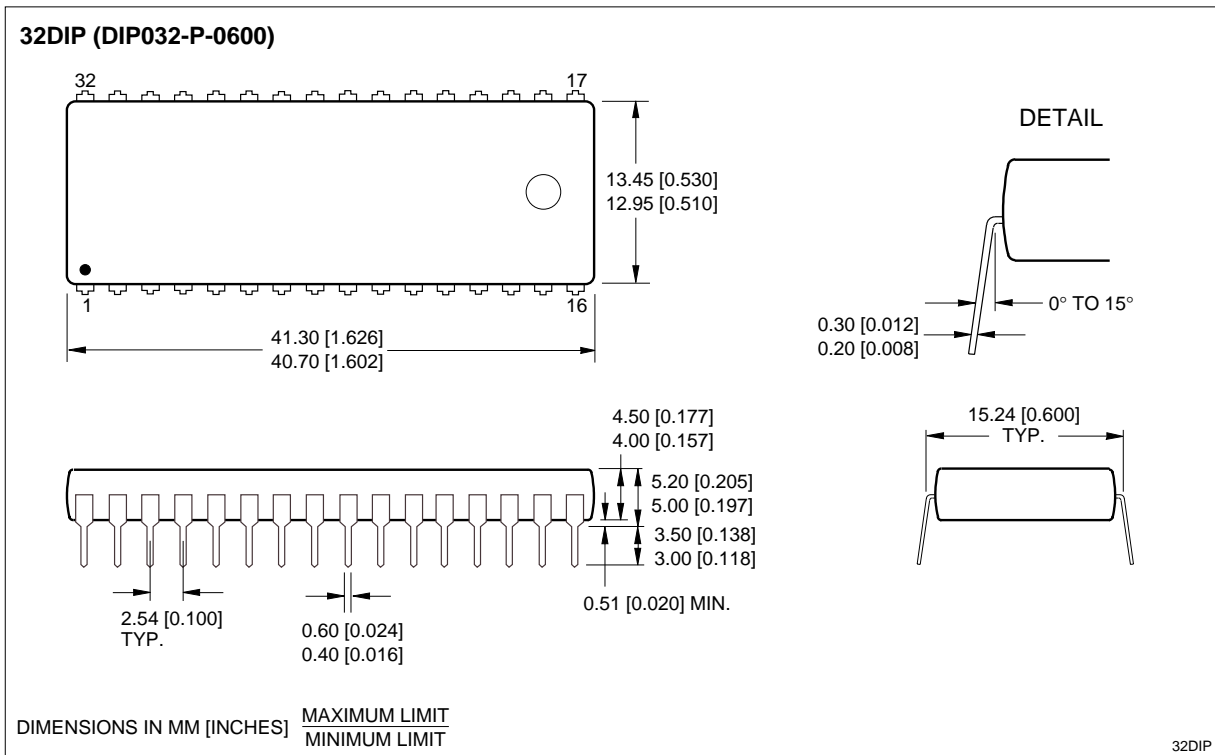
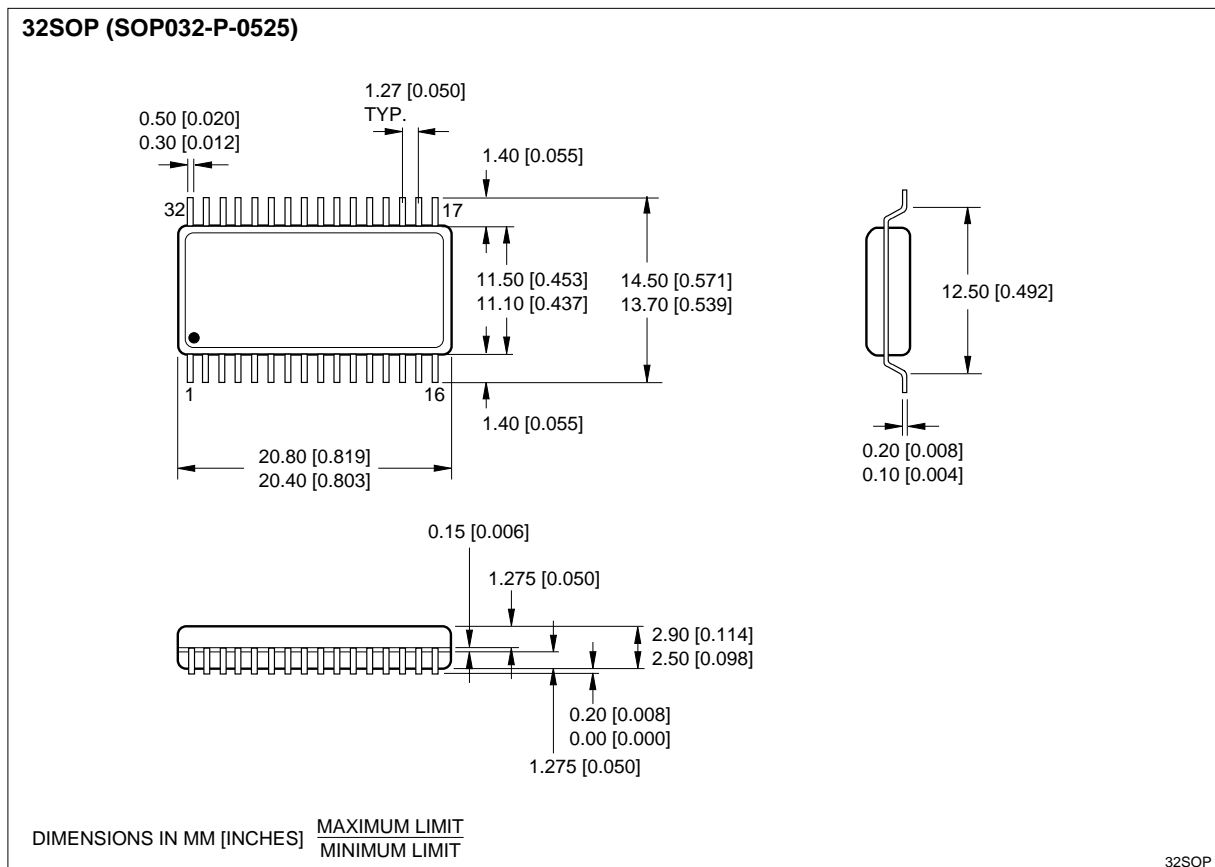


Figure 13. CS Standby Mode

PACKAGE DIAGRAMS

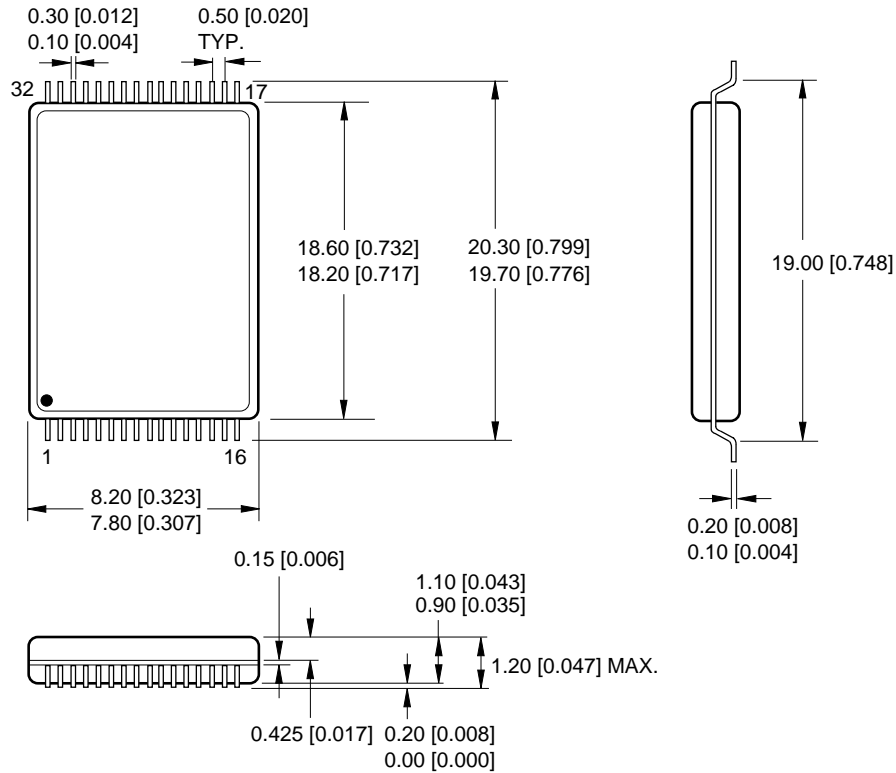


32-pin, 600-mil DIP



32-pin, 525-mil SOP

**32TSOP (Type I) (TSOP032-P-0820)**



DIMENSIONS IN MM [INCHES]    MAXIMUM LIMIT  
MINIMUM LIMIT

32TSOP

**32-pin, 8 × 20 mm<sup>2</sup> TSOP (Type I)**

**ORDERING INFORMATION**

LH5P8129	X	- ##	
Device Type	Package	Speed	
LH5P8129	X	<ul style="list-style-type: none"> <li>60 60</li> <li>80 80 Access Time (ns)</li> <li>10 100</li> </ul>	Blank 32-pin, 600-mil DIP (DIP032-P-0600)
			N 32-pin, 525-mil SOP (SOP032-P-0525)
			T 32-pin, 8 x 20 mm <sup>2</sup> TSOP (Type I) (TSOP032-P-0820)
		TR 32-pin, 8 x 20 mm <sup>2</sup> TSOP (Type I) Reverse bend (TSOP032-P-0820)	
CMOS 1M (128K x 8) Pseudo-Static RAM			

**Example:** LH5P8129N-60 (CMOS 1M (128K x 8) Pseudo-Static RAM, 60 ns, 32-pin, 525-mil SOP)

5P8129-14